Docket No.:

TK-0001

DECLARATION AND POWER OF ATTORNEY

DLCL	MITTON AND	POWER OF ATTORNEY
As a below named inventor, I hereby decl	lare that:	
My residence, post office and citizenship	are as stated below next to	my name,
I believe I am the original, first and sole in are listed below) of the subject matter clai NANOSIZED METAL PARTICLES, th	imed and for which a pater	is listed below) or an original, first and joint inventor (if plural names nt is sought on the invention entitled SYNTHESIS OF
[X] is attached hereto [] was filed on amended or	as A _I	oplication Serial No and was (if applicable)
I hereby state that I have reviewed and unany amendment referred to above.	iderstand the contents of t	he above identified specification, including the claims, as amended b
I acknowledge the duty to disclose inform Federal Regulations, Section 1.56(a).	nation which is known to n	ne to be material to patentability in accordance with Title 37, Code o
certificate, or 365(a) of any PCT internation	onal application which desi w, by checking the box, any	e 365 (b) of any foreign application(s) for patent or inventor's gnated at least one country other than the United States of America, y foreign application for patent or inventor's certificate, or of any application on which priority is claimed.
Prior Foreign Application(s): Number		Foreign Filing Date
	<u>Country</u>	Month/Day/Year
I hereby claim the benefit under 35 U.S.C.	. 119(e) of any United State	es provisional application(s) listed below.
Application Number(s):		te (Month/Day/Year)

I hereby claim the benefit under 35 U.S.C. 120 of any United States application(s), or 365(c) of any PCT international application designating the United States of America, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT international application in the manner provided by the first paragraph of 35 U.S.C. 112, I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR 1.56 which became available between the filing date of the prior application and the national or PCT international filing date of this application.

Prior U. S. Application or PCT Parent Number

Filing Date (Month/Day/Year)

Parent Patent Number (if applicable)

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

I hereby appoint the following attorney(s) and/or agent(s):

FLESHNER & KIM, LLP 2325 Dulles Corner Boulevard Suite 1100 Herndon, Virginia 20171

with full power of substitution and revocation, to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith, and all future correspondence should be addressed to them.

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